

## PROTECTION PRODUCTS - TransClamp™

### Description

A TransClamp™ is a low capacitance TVS array designed to protect high speed data interfaces. This series has been specifically designed to protect sensitive components which are connected to data and transmission lines from overvoltage caused by **ESD** (electrostatic discharge), **CDE** (Cable Discharge Events), and **Lightning**.

These devices integrate low capacitance, surge-rated compensation diodes with a high power transient voltage suppressor (TVS). The compensation diodes are arranged in a bridge pattern allowing the device to be connected in common mode and/or differential mode. This allows the designer maximum flexibility and reduces parts count. The capacitance of the device is limited to 12pF maximum from line-to-line to ensure correct signal transmission on high-speed lines. These devices may be used to meet Telcordia GR-1089-CORE short-haul (intra-building) surge requirements and will withstand a minimum 100 A surge for a 2/10μs pulse.

The TClamp™3302N is in a 10-pin, RoHS/WEEE compliant, SLP2626P10 package. It measures 2.6 x 2.6 x 0.60mm. The leads are spaced at a pitch of 0.5mm and are finished with lead-free NiPdAu. They are particularly well suited for applications where board space is at a premium such as integrated connectors/magnetics and carrier class Ethernet equipment.

### Features

- ◆ Transient protection for high-speed data lines to **Bellcore 1089 (Intra-Building) 100A (2/10μs)**  
**IEC 61000-4-2 (ESD) ±15kV (air), ±8kV (contact)**  
**IEC 61000-4-4 (EFT) 40A (5/50ns)**  
**IEC 61000-4-5 (Lightning) L5, 95A (8/20μs)**
- ◆ Low capacitance (12pF line-to-line)
- ◆ Low operating voltages (**3.3V**)
- ◆ Low clamping voltage
- ◆ Small SLP Package saves board space
- ◆ Solid-state technology

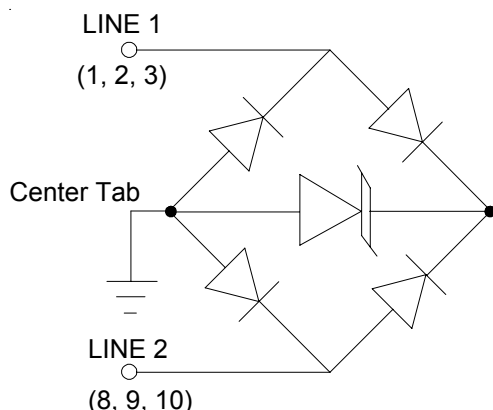
### Mechanical Characteristics

- ◆ SLP2626P10 10L package
- ◆ RoHS/WEEE Compliant
- ◆ Nominal Dimensions: 2.6 x 2.6 x 0.60 mm
- ◆ Lead Pitch: 0.5mm
- ◆ Molding compound flammability rating: UL 94V-0
- ◆ Marking: Marking Code
- ◆ Packaging: Tape and Reel

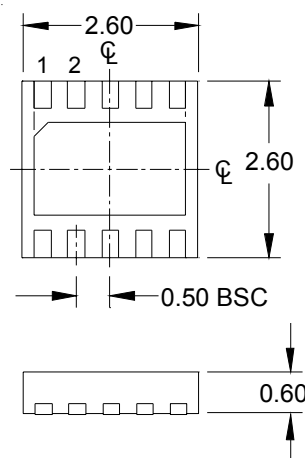
### Applications

- ◆ 10/100/1000 Ethernet
- ◆ T3/E3
- ◆ Integrated Magnetics
- ◆ Carrier Class Equipment
- ◆ Customer Premise Equipment

### Circuit Diagram



### Package Configuration



**10 Pin SLP package (Bottom Side View)**  
**Nominal Dimensions in mm**

**PROTECTION PRODUCTS**
**Absolute Maximum Rating**

| Rating                                                         | Symbol           | Value       | Units |
|----------------------------------------------------------------|------------------|-------------|-------|
| Peak Pulse Power (tp = 2/10μs)                                 | P <sub>pk</sub>  | 2500        | Watts |
| Peak Pulse Current (tp = 2/10μs)                               | I <sub>pp</sub>  | 120         | A     |
| Peak Pulse Current (tp = 8/20μs)                               | I <sub>pp</sub>  | 95          | A     |
| ESD per IEC 61000-4-2 (Air)<br>ESD per IEC 61000-4-2 (Contact) | V <sub>ESD</sub> | 30<br>30    | kV    |
| Operating Temperature                                          | T <sub>J</sub>   | -40 to +85  | °C    |
| Storage Temperature                                            | T <sub>STG</sub> | -55 to +150 | °C    |

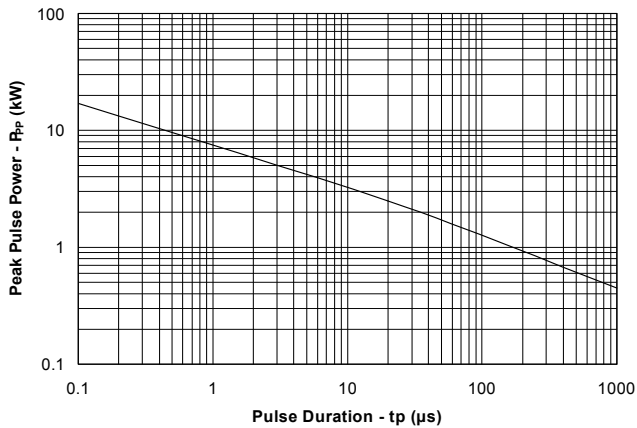
**Electrical Characteristics (T=25°C unless otherwise specified)**

| <b>TClamp3302N</b>        |                  |                                                              |         |         |         |       |
|---------------------------|------------------|--------------------------------------------------------------|---------|---------|---------|-------|
| Parameter                 | Symbol           | Conditions                                                   | Minimum | Typical | Maximum | Units |
| Reverse Stand-Off Voltage | V <sub>RWM</sub> | T=25°C to 85°C                                               |         |         | 3.3     | V     |
| Punch-Through Voltage     | V <sub>PT</sub>  | I <sub>PT</sub> = 2μA<br>T=25°C                              | 3.5     |         |         | V     |
| Snap-Back Voltage         | V <sub>SB</sub>  | I <sub>SB</sub> = 50mA                                       | 2.8     |         |         | V     |
| Reverse Leakage Current   | I <sub>R</sub>   | V <sub>RWM</sub> = 3.3V, T=25°C                              |         |         | 1       | μA    |
| Clamping Voltage          | V <sub>C</sub>   | I <sub>pp</sub> = 100A, tp = 2/10μs<br>Line-to-Ground        |         |         | 22      | V     |
| Clamping Voltage          | V <sub>C</sub>   | I <sub>pp</sub> = 100A, tp = 2/10μs<br>Line-to-Line          |         |         | 25      | V     |
| Junction Capacitance      | C <sub>J</sub>   | Between I/O pins and<br>Gnd<br>V <sub>R</sub> = 0V, f = 1MHz |         |         | 25      | pF    |
|                           |                  | Between I/O pins<br>V <sub>R</sub> = 0V, f = 1MHz            |         |         | 12      | pF    |

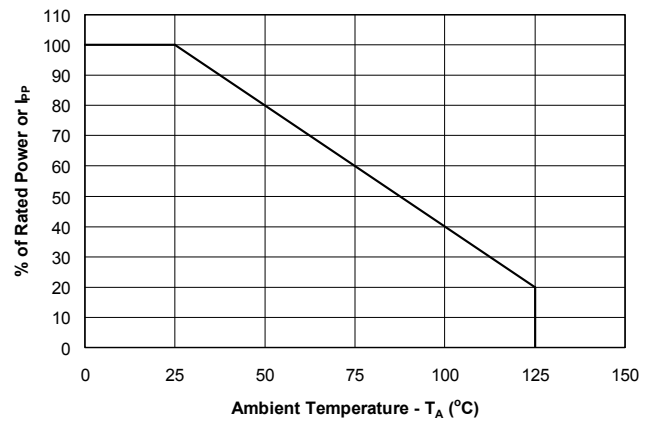
## PROTECTION PRODUCTS

### Typical Characteristics

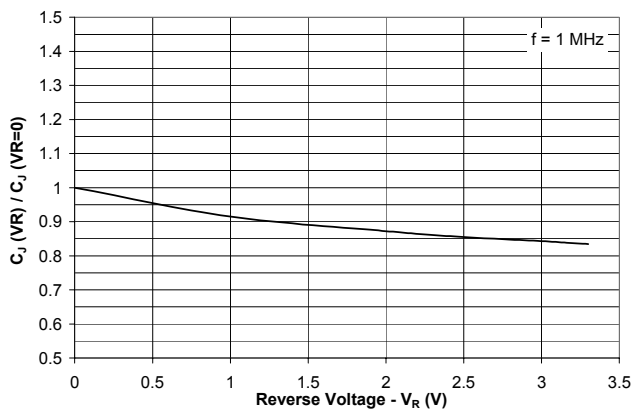
#### Non-Repetitive Peak Pulse Power vs. Pulse Time



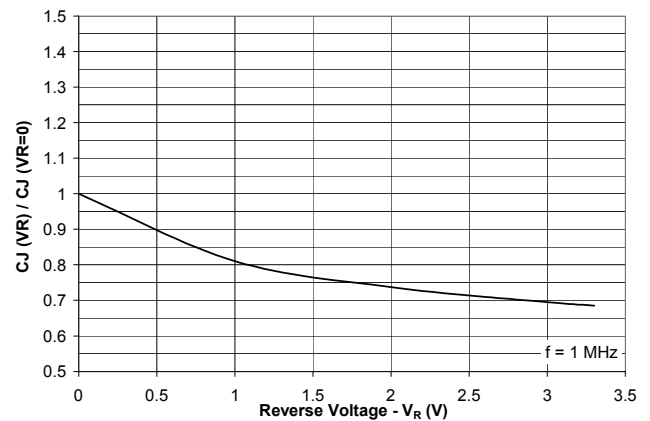
#### Power Derating Curve



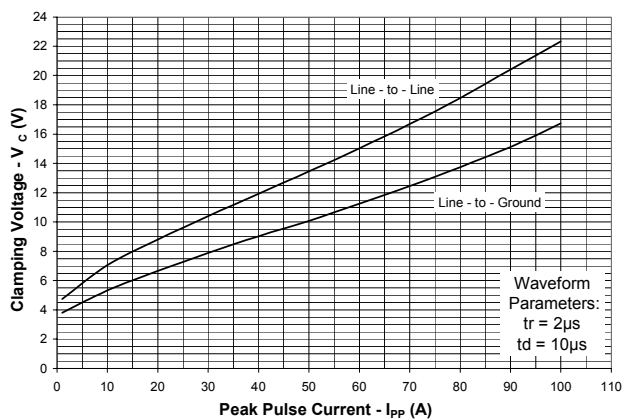
#### Normalized Junction Capacitance vs. Reverse Voltage (Line-to-Line)



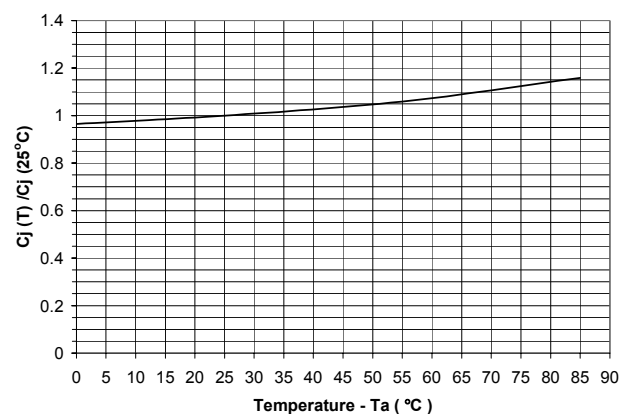
#### Normalized Junction Capacitance vs. Reverse Voltage (Line-to-Ground)



#### Clamping Voltage vs. Peak Pulse Current



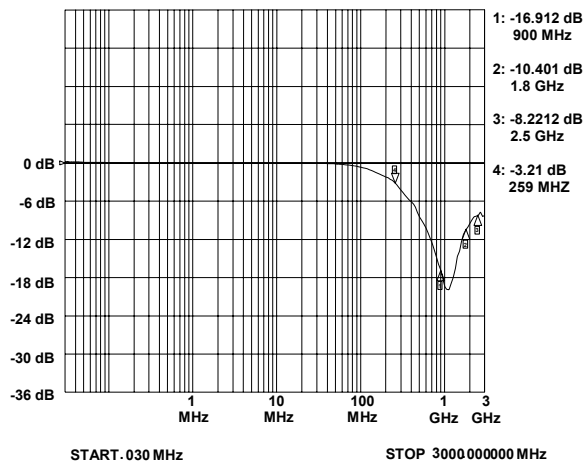
#### Normalized Junction Capacitance vs. Temperature



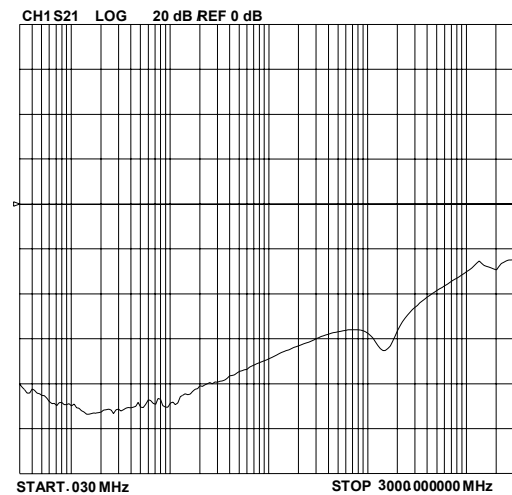
## PROTECTION PRODUCTS

### Typical Characteristics

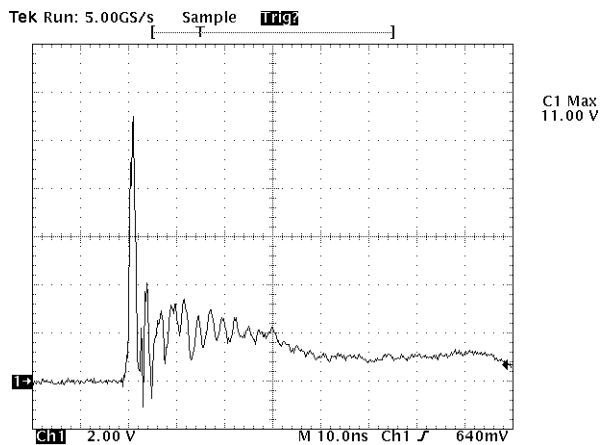
**Typical Insertion Loss S21 (Each Line)**



**Analog Crosstalk (Each Line)**

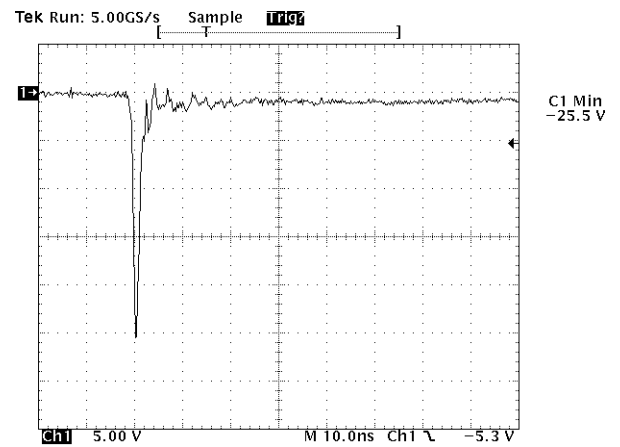


**ESD Clamping  
(+8kV per IEC 61000-4-2)**



Note: Data is taken with a 10x attenuator

**ESD Clamping  
(-8kV per IEC 61000-4-2)**



Note: Data is taken with a 10x attenuator

## PROTECTION PRODUCTS

### Applications Information

#### Device Connection Options for Protection of Two High-Speed Data Lines

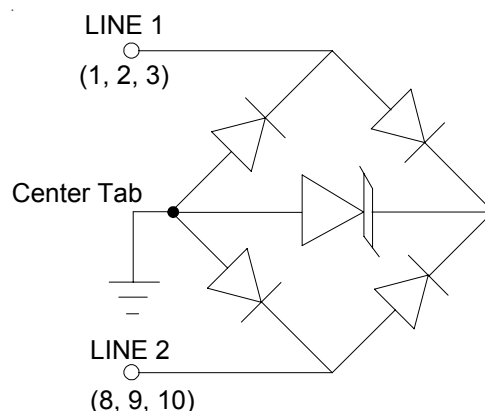
These devices are designed to protect two high-speed data lines (one differential pair) from transient over-voltages which result from lightning and ESD. They can be configured to protect in differential (Line-to-Line) and common (Line-to-Ground) mode. Data line inputs/outputs are connected at pins 1, 2 and 3, and 8, 9 and 10 as shown. For proper operation, pins 1 - 3 must be connected together and pins 8 - 10 must be connected together. Pins 4, 5, 6, and 7 may be left unconnected. For differential operation, the center tab is also left not connected. For common mode operation, the center tab is connected to ground. The ground connection should be made directly to a ground plane on the board for best results. The use of multiple vias is recommended for reduced ground loop inductance.

#### Short-Haul/Intrabuilding Immunity Requirements for Ethernet-based Systems

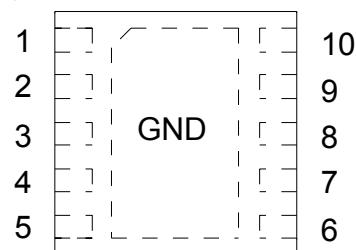
The accelerating demand for bandwidth-hungry services such as Voice over IP, Metropolitan Area Networks (MAN), Ethernet over telecommunications backplanes, and broadband to the home are driving the deployment of high-reliability carrier and enterprise class Ethernet-based systems. These systems require the robust protection of external ports from transient voltage events such as lightning, electrostatic discharge, and cable discharge events. Each new generation of Ethernet deployment yields higher-density boards that demand protection solutions that occupy less board space.

The Telcordia Technologies (Bellcore) GR-1089-CORE specification defines a set of requirements for lightning and AC power cross immunity for intrabuilding equipment. The lightning tests are applied as metallic (line-to-line) or longitudinal (line-to-ground) waveforms. The waveforms are defined with a rise time of  $2\mu\text{s}$  and a decay time of  $10\mu\text{s}$  with a short circuit current of 100A. One surge of positive and one of negative polarity are applied. To pass the test, the equipment must continue to operate after the test. If a  $2/10\mu\text{s}$  generator is unavailable, then a  $8/20\mu\text{s}$  waveform may be applied with additional series resistance ( $6\Omega$  metallic,  $12\Omega$  longitudinal).

#### Circuit Diagram



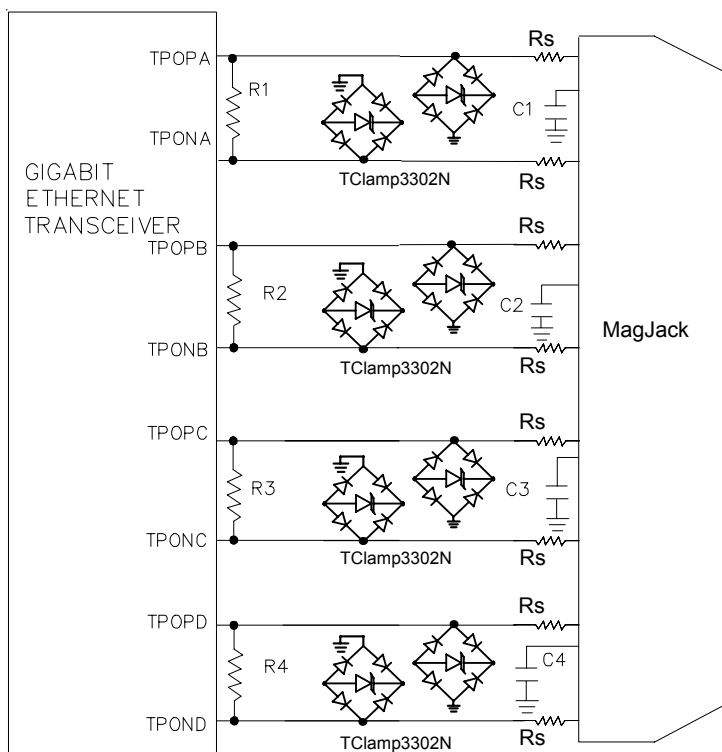
#### Pin Configuration (Top Side View)



| Pin        | Identification |
|------------|----------------|
| 1, 2, 3    | Line 1 in/out  |
| 8, 9, 10   | Line 2 in/out  |
| 4, 5, 6, 7 | No Connect     |
| Center Tab | Ground         |

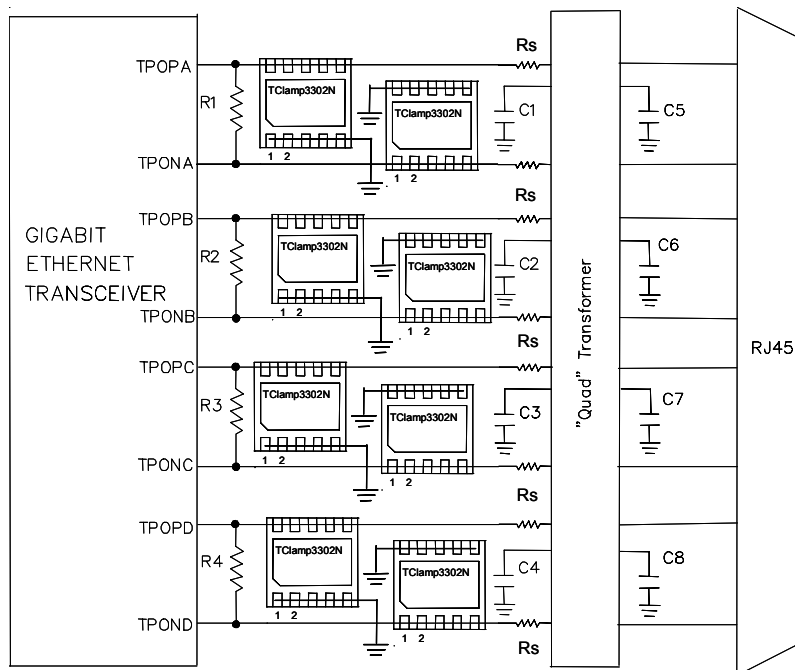
## PROTECTION PRODUCTS

### Typical Applications



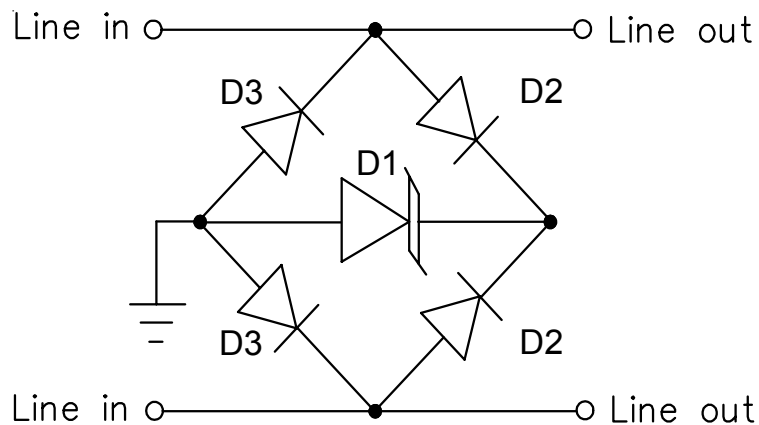
Note:  $R_s = 2\ \Omega$ , 1% tolerance

### Schematic Diagram for Telcordia GR-1089 Intra-Building Protection Gigabit Ethernet with Magjack



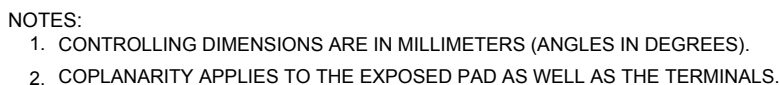
Note:  $R_s = 2\ \Omega$ , 1% tolerance

### Layout Diagram for Telcordia GR- 1089 Intra-Building Protection Gigabit Ethernet

**PROTECTION PRODUCTS**
**Applications Information - Spice Model**
**TClamp3302N Spice Model & Parameters**

**TClamp3302N Spice Model**

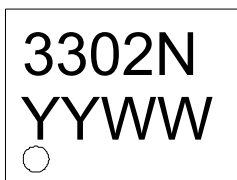
| <b>TClamp3302N Spice Parameters</b> |             |                 |                  |                  |
|-------------------------------------|-------------|-----------------|------------------|------------------|
| <b>Parameter</b>                    | <b>Unit</b> | <b>D1 (TVS)</b> | <b>D2 (LCRD)</b> | <b>D3 (LCRD)</b> |
| IS                                  | Amp         | 1.4E-11         | 1.001E-20        | 1.001E-20        |
| BV                                  | Volt        | 3.3             | 150              | 150              |
| VJ                                  | Volt        | 8               | 0.59             | 0.59             |
| RS                                  | Ohm         | 0.04            | 0.075            | 0.05             |
| IBV                                 | Amp         | 1E-3            | 1E-3             | 1E-3             |
| CJO                                 | Farad       | 400e-12         | 11.0E-12         | 11.0E-12         |
| TT                                  | sec         | 2.541E-9        | 2.541E-9         | 2.541E-9         |
| M                                   | –           | 0.256           | 0.01             | 0.01             |
| N                                   | –           | 1.1             | 1.1              | 1.1              |
| EG                                  | eV          | 1.11            | 1.11             | 1.11             |

# Outline Drawing - SLP2626P10



NOTES:

1. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

**PROTECTION PRODUCTS**
**Marking**


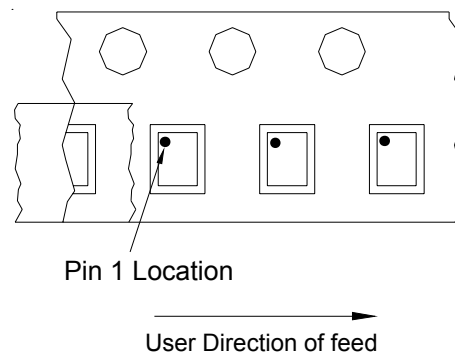
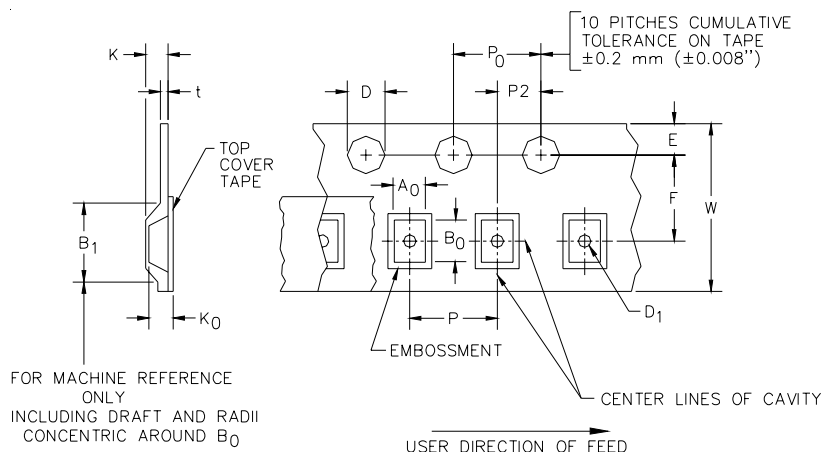
YY = year  
WW = Week

**Ordering Information**

| Part Number     | Qty per Reel | Reel Size |
|-----------------|--------------|-----------|
| TClamp3302N.TCT | 3,000        | 7 Inch    |

Note: Lead finish is lead-free NiPdAu

TransClamp and TClamp are marks of Semtech Corporation

**Tape and Reel Specification**

**Device Orientation in Tape**

| A0              | B0              | K0              |
|-----------------|-----------------|-----------------|
| 2.77 +/-0.10 mm | 2.77 +/-0.10 mm | 0.80 +/-0.10 mm |

| Tape Width | B, (Max)      | D                     | D1           | E            | F           | K (MAX) | P          | P0         | P2          | T(MAX) | W                        |
|------------|---------------|-----------------------|--------------|--------------|-------------|---------|------------|------------|-------------|--------|--------------------------|
| 8 mm       | 4.2 mm (.165) | 1.5 + 0.1 mm - 0.0 mm | 1.0 mm ±0.05 | 1.750±.10 mm | 3.5±0.05 mm | 2.4 mm  | 4.0±0.1 mm | 4.0±0.1 mm | 2.0±0.05 mm | 0.4 mm | 8.0 mm + 0.3 mm - 0.1 mm |

**Contact Information**

Semtech Corporation  
Protection Products Division  
200 Flynn Rd., Camarillo, CA 93012  
Phone: (805)498-2111 FAX (805)498-3804



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.